

DS3691 (RS-422/RS-423) Line Drivers with TRI-STATE Outputs

Check for Samples: [DS1691A](#), [DS3691](#)

FEATURES

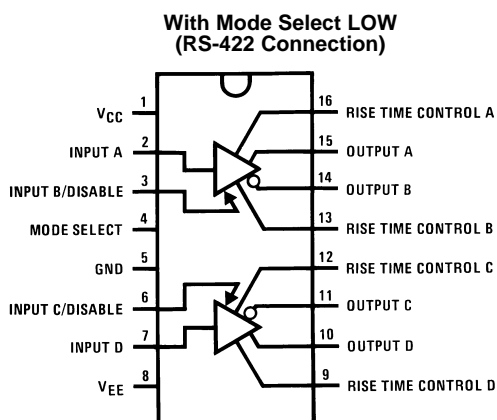
- Dual RS-422 Line Driver with Mode Pin Low, or Quad RS-423 Line Driver with Mode Pin High
- TRI-STATE Outputs in RS-422 Mode
- Short Circuit Protection for Both Source and Sink Outputs
- Outputs Will Not Clamp Line with Power Off or In TRI-STATE
- 100Ω Transmission Line Drive Capability
- Low I_{CC} and I_{EE} Power Consumption
 - RS-422: $I_{CC} = 9$ mA/driver Typ
 - RS-423: $I_{CC} = 4.5$ mA/driver Typ
 - $I_{EE} = 2.5$ mA/driver Typ
- Low Current PNP Inputs Compatible with TTL, MOS and CMOS
- Pin Compatible with AM26LS30

DESCRIPTION

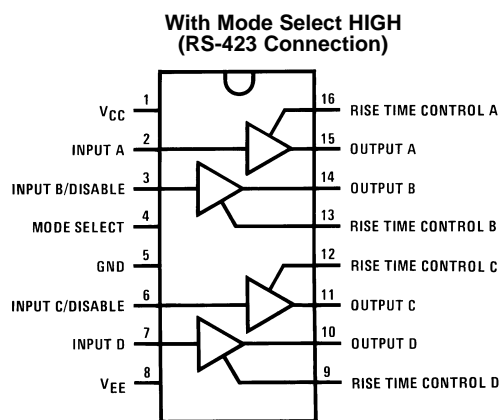
The DS3691 is a low power Schottky TTL line driver designed to meet the requirements of EIA standards RS-422 and RS-423. It features 4 buffered outputs with high source and sink current capability with internal short circuit protection. A mode control input provides a choice of operation either as 4 single-ended line drivers or 2 differential line drivers. A rise time control pin allows the use of an external capacitor to slow the rise time for suppression of near end crosstalk to other receivers in the cable. Rise time capacitors are primarily intended for waveshaping output signals in the single-ended driver mode. Multipoint applications in differential mode with waveshaping capacitors is not allowed.

With the mode select pin low, the DS3691 are dual-differential line drivers with TRI-STATE outputs. They feature $\pm 10V$ output common-mode range in TRI-STATE mode and 0V output unbalance when operated with $\pm 5V$ supply.

Connection Diagrams



**Figure 1. SOIC Package
See Package Number D0016A
Top View**



**Figure 2. SOIC Package
See Package Number D0016A
Top View**



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.



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Absolute Maximum Ratings⁽¹⁾⁽²⁾

Supply Voltage	V _{CC}	7V
	V _{EE}	–7V
Maximum Power Dissipation at 25°C SOIC Package ⁽³⁾		1051 mW
Input Voltage		15V
Output Voltage (Power OFF)		±15V
Storage Temperature		–65°C to + 150°C
Lead Temperature (Soldering, 4 seconds)		260°C

- (1) “Absolute Maximum Ratings” are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The tables of “Electrical Characteristics” provide conditions for actual device operation.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.
- (3) Derate SOIC package 8.41 mW/°C above 25°C.

Operating Conditions

		Min	Max	Units
Supply Voltage	V _{CC}	4.75	5.25	V
	V _{EE}	–4.75	–5.25	V
Temperature, T _A		0	+70	°C

DC Electrical Characteristics⁽¹⁾⁽²⁾⁽³⁾⁽⁴⁾

Parameter		Test Conditions		Min	Typ	Max	Units
RS-422 CONNECTION, V _{EE} CONNECTION TO GROUND, MODE SELECT ≤ 0.8V							
V _{IH}	High Level Input Voltage			2			V
V _{IL}	Low Level Input Voltage					0.8	V
I _{IH}	High Level Input Current	V _{IN} = 2.4V			1	40	μA
		V _{IN} ≤ 15V			10	100	μA
I _{IL}	Low Level Input Current	V _{IN} = 0.4V			-30	-200	μA
V _I	Input Clamp Voltage	I _{IN} = -12 mA				-1.5	V
$\frac{V_O}{V_O}$	Differential Output Voltage V _{A,B}	R _L = ∞	V _{IN} = 2V		3.6	6.0	V
			V _{IN} = 0.8V		-3.6	-6.0	V
$\frac{V_T}{V_T}$	Differential Output Voltage V _{A,B}	R _L = 100Ω V _{CC} ≥ 4.75V	V _{IN} = 2V	2	2.4		V
			V _{IN} = 0.8V	-2	-2.4		V
V _{OS} , $\overline{V_{OS}}$	Common-Mode Offset Voltage	R _L = 100Ω			2.5	3	V
V _T - $\overline{V_T}$	Difference in Differential Output Voltage	R _L = 100Ω			0.05	0.4	V
V _{OS} - $\overline{V_{OS}}$	Difference in Common-Mode Offset Voltage	R _L = 100Ω			0.05	0.4	V
V _{SS}	V _T - $\overline{V_T}$	R _L = 100Ω, V _{CC} ≥ 4.75V		4.0	4.8		V
V _{CMR}	Output Voltage Common-Mode Range	V _{DISABLE} = 2.4V		±10			V
I _{XA}	Output Leakage Current	V _{CC} = 0V	V _{CMR} = 10V			100	μA
I _{XB}	Power OFF		V _{CMR} = -10V			-100	μA
I _{OX}	TRI-STATE Output Current	V _{CC} = Max V _{EE} = 0V and -5V	V _{CMR} ≤ 10V			100	μA
			V _{CMR} ≥ -10V			-100	μA
I _{SA}	Output Short Circuit Current	V _{IN} = 0.4V	V _{OA} = 6V		80	150	mA
			V _{OB} = 0V		-80	-150	mA
I _{SB}	Output Short Circuit Current	V _{IN} = 2.4V	V _{OA} = 0V		-80	-150	mA
			V _{OB} = 6V		80	150	mA
I _{CC}	Supply Current				18	30	mA

- (1) Unless otherwise specified, min/max limits apply across the -55°C to +125°C temperature range for the DS1691A and across the 0°C to +70°C range for the DS3691. All typicals are given for V_{CC} = 5V and T_A = 25°C. V_{CC} and V_{EE} as listed in operating conditions.
- (2) All currents into device pins are positive; all currents out of device pins are negative. All voltages are referenced to ground unless otherwise specified.
- (3) Only one output at a time should be shorted.
- (4) Symbols and definitions correspond to EIA RS-422 and/or RS-423 where applicable.

AC Electrical Characteristics⁽¹⁾

T_A = 25°C

Parameter		Test Conditions	Min	Typ	Max	Units
RS-422 CONNECTION, V _{CC} = 5V, MODE SELECT = 0.8V						
t _r	Output Rise Time	R _L = 100Ω, C _L = 500 pF Figure 3		120	200	ns
t _f	Output Fall Time	R _L = 100Ω, C _L = 500 pF Figure 3		120	200	ns
t _{PDH}	Output Propagation Delay	R _L = 100Ω, C _L = 500 pF Figure 3		120	200	ns
t _{PDL}	Output Propagation Delay	R _L = 100Ω, C _L = 500 pF Figure 3		120	200	ns
t _{PZL}	TRI-STATE Delay	R _L = 450Ω, C _L = 500 pF, C _C = 0 pF Figure 6		250	350	ns
t _{PZH}	TRI-STATE Delay	R _L = 450Ω, C _L = 500 pF, C _C = 0 pF Figure 6		180	300	ns
t _{PLZ}	TRI-STATE Delay	R _L = 450Ω, C _L = 500 pF, C _C = 0 pF Figure 6		180	300	ns
t _{PHZ}	TRI-STATE Delay	R _L = 450Ω, C _L = 500 pF, C _C = 0 pF Figure 6		250	350	ns

- (1) Symbols and definitions correspond to EIA RS-422 and/or RS-423 where applicable.

DC Electrical Characteristics⁽¹⁾⁽²⁾⁽³⁾⁽⁴⁾

Parameter		Test Conditions		Min	Typ	Max	Units
RS-423 CONNECTION, V _{CC} = V _{EE} , MODE SELECT ≥ 2V							
V _{IH}	High Level Input Voltage			2			V
V _{IL}	Low Level Input Voltage					0.8	V
I _{IH}	High Level Input Current	V _{IN} = 2.4V			1	40	μA
		V _{IN} ≤ 15V			10	100	μA
I _{IL}	Low Level Input Current	V _{IN} = 0.4V			-30	-200	μA
V _I	Input Clamp Voltage	I _{IN} = -12 mA				-1.5	V
$\frac{V_O}{V_O}$	Output Voltage	R _L = ∞, See ⁽⁵⁾ V _{CC} ≥ 4.75V	V _{IN} = 2V	4.0	4.4	6.0	V
			V _{IN} = 0.4V	-4.0	-4.4	-6.0	V
$\frac{V_T}{V_T}$	Output Voltage	R _L = 450Ω V _{CC} ≥ 4.75V	V _{IN} = 2.4V	3.6	4.1		V
			V _{IN} = 0.4V	-3.6	-4.1		V
V _{TI} - V _T ⁻	Output Unbalance	V _{CC} = V _{EE} = 4.75V, R _L = 450Ω			0.02	0.4	V
I _X ⁺	Output Leakage Power OFF	V _{CC} = V _{EE} = 0V	V _O = 6V		2	100	μA
I _X ⁻	Output Leakage Power OFF	V _{CC} = V _{EE} = 0V	V _O = -6V		-2	-100	μA
I _S ⁺	Output Short Circuit Current	V _O = 0V	V _{IN} = 2.4V		-80	-150	mA
I _S ⁻	Output Short Circuit Current	V _O = 0V	V _{IN} = 0.4V		80	150	mA
I _{SLEW}	Slew Control Current				±140		μA
I _{CC}	Positive Supply Current	V _{IN} = 0.4V, R _L = ∞			18	30	mA
I _{EE}	Negative Supply Current	V _{IN} = 0.4V, R _L = ∞			-10	-22	mA

- (1) Unless otherwise specified, min/max limits apply across the -55°C to $+125^\circ\text{C}$ temperature range for the DS1691A and across the 0°C to $+70^\circ\text{C}$ range for the DS3691. All typicals are given for $V_{CC} = 5V$ and $T_A = 25^\circ\text{C}$. V_{CC} and V_{EE} as listed in operating conditions.
- (2) All currents into device pins are positive; all currents out of device pins are negative. All voltages are referenced to ground unless otherwise specified.
- (3) Only one output at a time should be shorted.
- (4) Symbols and definitions correspond to EIA RS-422 and/or RS-423 where applicable.
- (5) At -55°C , the output voltage is $+3.9V$ minimum and $-3.9V$ minimum.

AC Electrical Characteristics⁽¹⁾ $T_A = 25^\circ\text{C}$

Parameter		Test Conditions	Min	Typ	Max	Units
RS-423 CONNECTION, V _{CC} = 5V, V _{EE} -5V, MODE SELECT = 2.4V						
t _r	Rise Time	R _L = 450Ω, C _L = 500 pF, C _C = 0 Figure 4		120	300	ns
t _f	Fall Time	R _L = 450Ω, C _L = 500 pF, C _C = 0 Figure 4		120	300	ns
t _r	Rise Time	R _L = 450Ω, C _L = 500 pF C _C = 50 pF Figure 5		3.0		μs
t _f	Fall Time	R _L = 450Ω, C _L = 500 pF C _C = 50 pF Figure 5		3.0		μs
t _{rc}	Rise Time Coefficient	R _L = 450Ω, C _L = 500 pF, C _C = 50 pF Figure 5		0.06		μs/pF
t _{PDH}	Output Propagation Delay	R _L = 450Ω, C _L = 500 pF, C _C = 0 Figure 4		180	300	ns
t _{PDL}	Output Propagation Delay	R _L = 450Ω, C _L = 500 pF, C _C = 0 Figure 4		180	300	ns

- (1) Symbols and definitions correspond to EIA RS-422 and/or RS-423 where applicable.

AC Test Circuits and Switching Time Waveforms

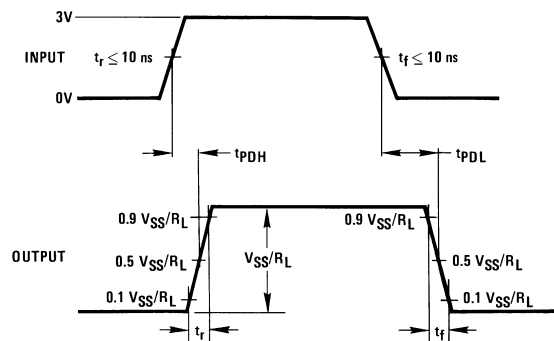
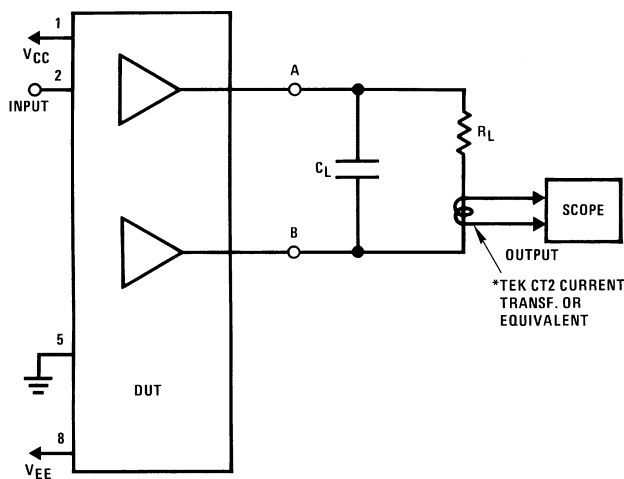


Figure 3. Differential Connection

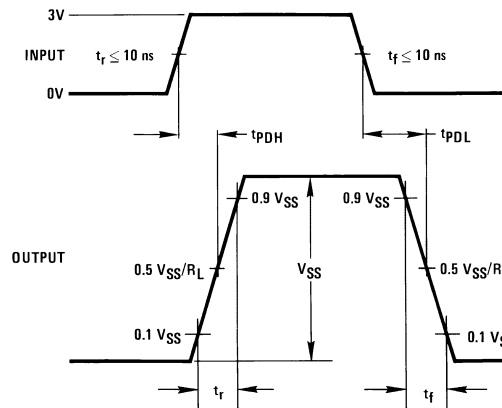
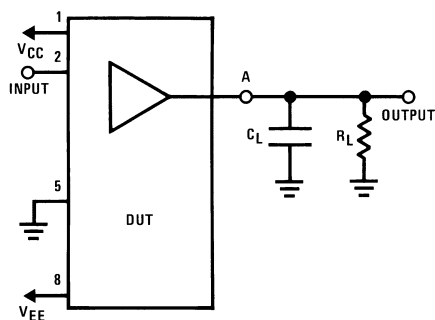
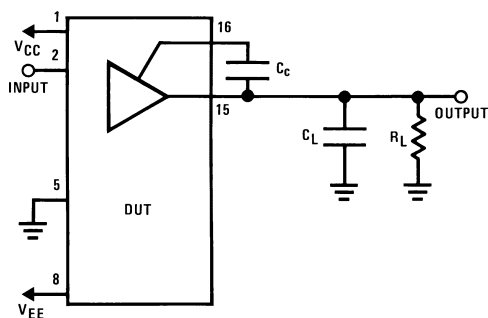


Figure 4. RS-423 Connection



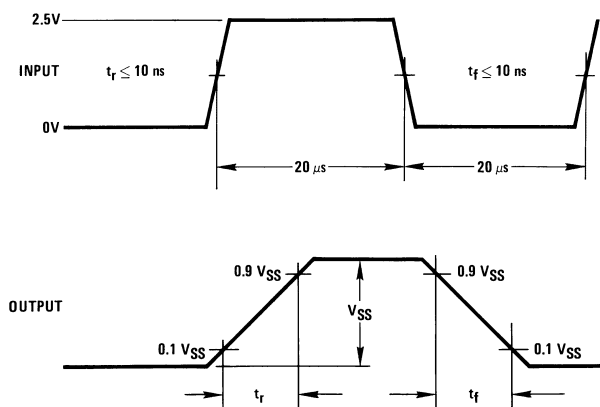


Figure 5. Rise Time Control for RS-423

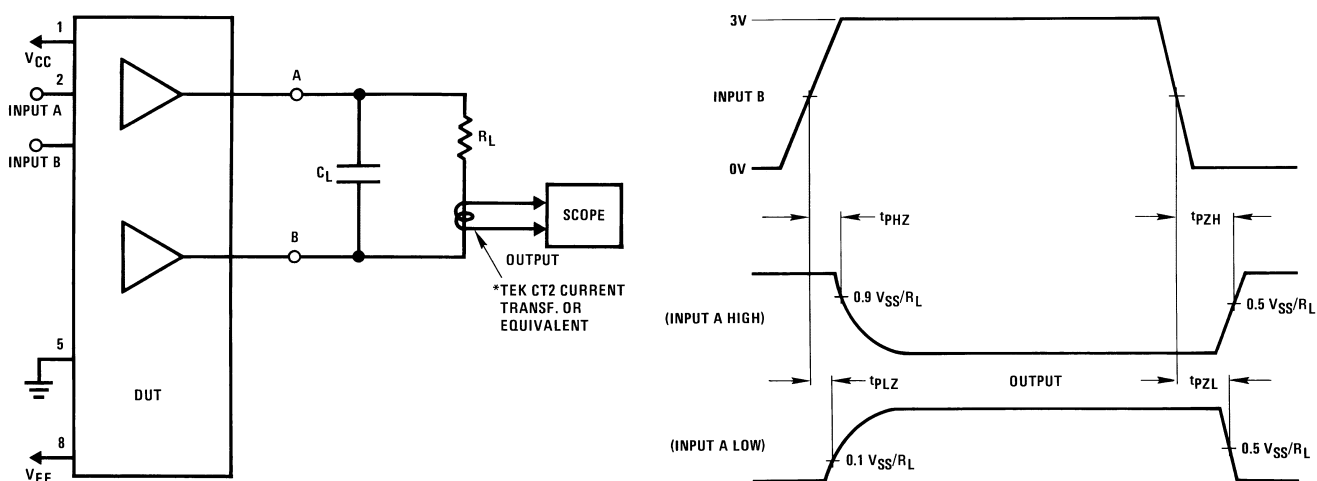


Figure 6. TRI-STATE Delays

SWITCHING WAVEFORMS

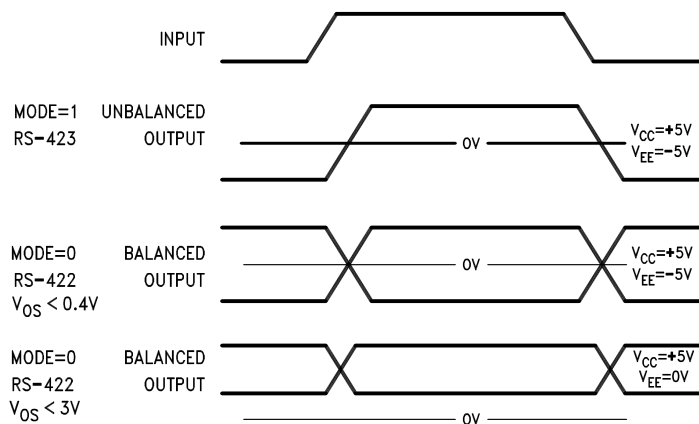


Figure 7. Typical Output Voltage

Truth Table

Operation	Inputs			Outputs	
	Mode	A (D)	B (C)	A (D)	B (C)
RS-422	0	0	0	0	1
	0	0	1	TRI-STATE	TRI-STATE
	0	1	0	1	0
	0	1	1	TRI-STATE	TRI-STATE
RS-423	1	0	0	0	0
	1	0	1	0	1
	1	1	0	1	0
	1	1	1	1	1

TYPICAL APPLICATION INFORMATION

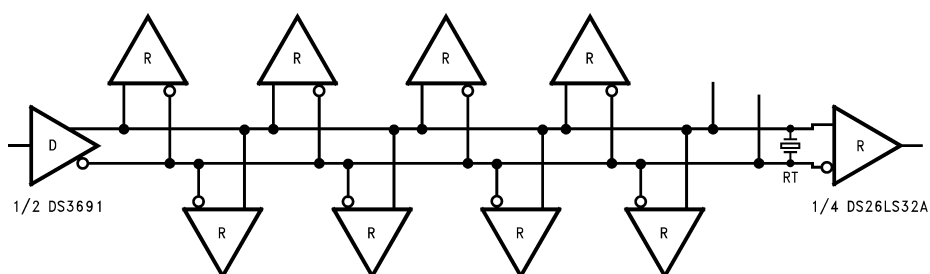


Figure 8. Fully Loaded RS-422 Interface

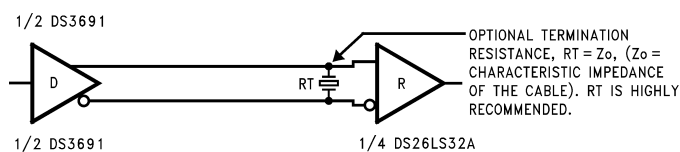


Figure 9. RS-422 Point to Point Application

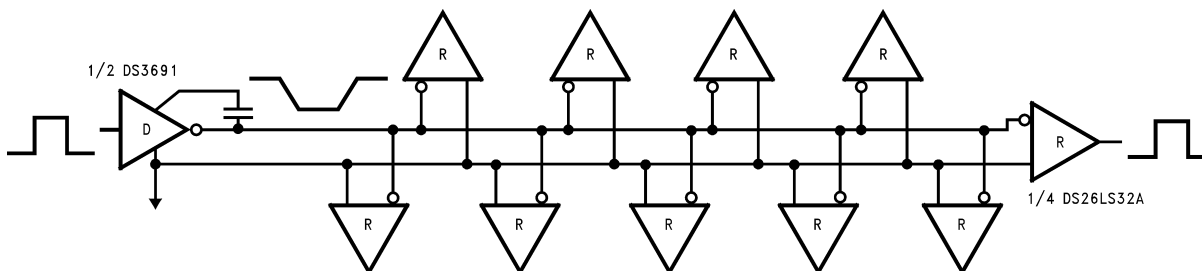
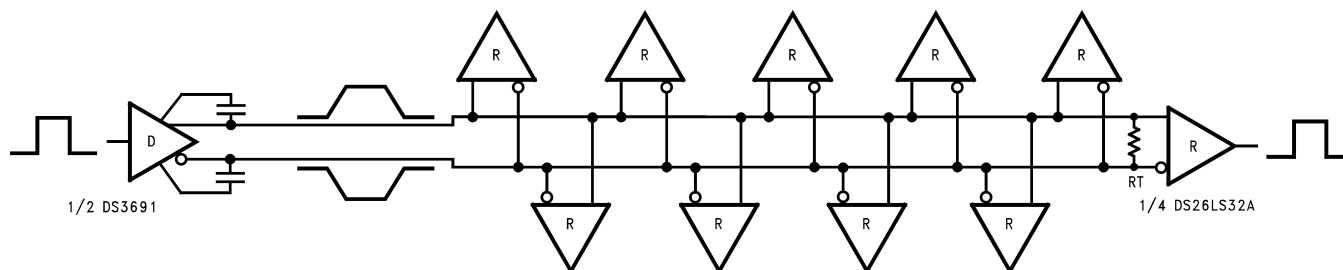


Figure 10. Fully Loaded RS-423 Interface



***Note:** Controlled edge allows longer stub lengths. Multiple Drivers are NOT allowed.

Figure 11. Differential Application with Rise Time Control

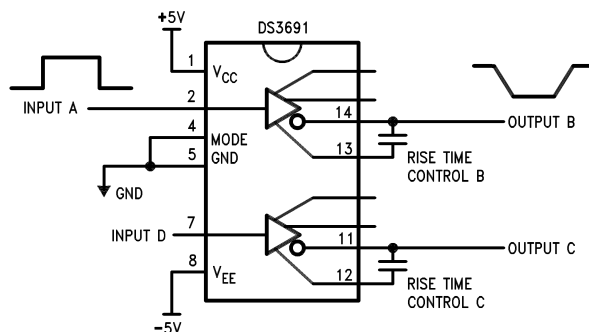


Figure 12. Dual RS-423 Inverting Driver

Typical Rise Time Control Characteristics

(RS-423 Mode)

Rise Time vs External Capacitor

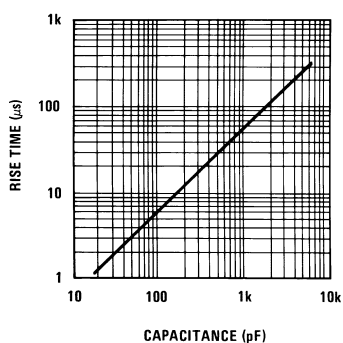


Figure 13.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
DS3691M	ACTIVE	SOIC	D	16	48	TBD	Call TI	Call TI	0 to 70	DS3691M AM26LS30SC	Samples
DS3691M/NOPB	ACTIVE	SOIC	D	16	48	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	0 to 70	DS3691M AM26LS30SC	Samples
DS3691MX	ACTIVE	SOIC	D	16	2500	TBD	Call TI	Call TI	0 to 70	DS3691M AM26LS30SC	Samples
DS3691MX/NOPB	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	0 to 70	DS3691M AM26LS30SC	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

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(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Only one of markings shown within the brackets will appear on the physical device.

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*All dimensions are nominal

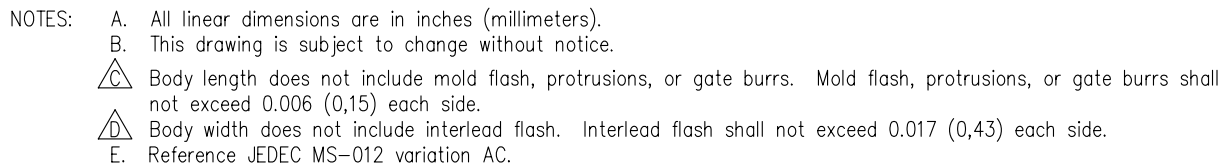
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
DS3691MX	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.3	8.0	16.0	Q1
DS3691MX/NOPB	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.3	8.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
DS3691MX	SOIC	D	16	2500	367.0	367.0	35.0
DS3691MX/NOPB	SOIC	D	16	2500	367.0	367.0	35.0



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